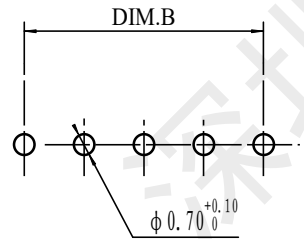
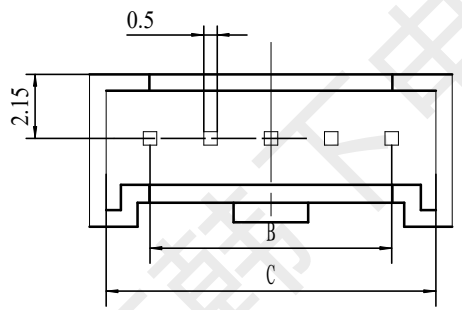
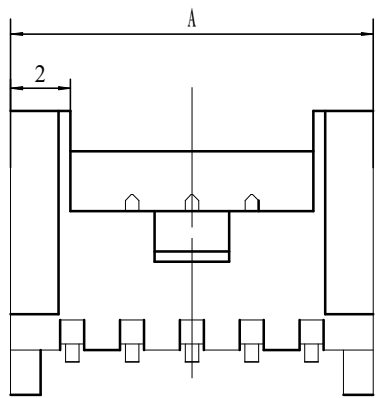
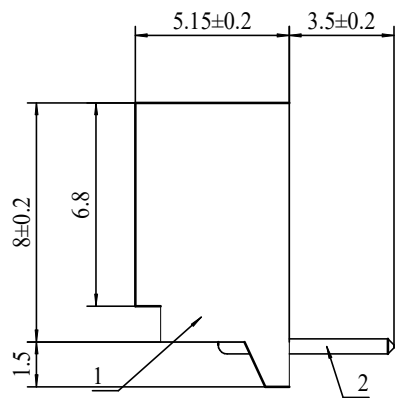


| REV. | EC# | DESCRIPTION | DATE | DRAWN | CHECK | APPROVED |
|------|-----|-------------|-----------|-------|-------|----------|
| 1.00 | | 初版发行 | 2020-8-28 | | | |



PCB LAYOUT

| GENERAL TOLERANCES | | | |
|--------------------|-------|--------|--------|
| DIM | TOL | DIM | DEG |
| X. | | X° | ±3.00° |
| X.X | ±0.35 | X.X° | ±2.00° |
| X.XX | ±0.25 | X.XX° | ±1.00° |
| X.XXX | ±0.15 | X.XXX° | |

| NUMBER OF PINS | DIM. A | DIM. B | DIM. C |
|----------------|--------|--------|--------|
| 15P | 32.0 | 28.0 | 30.9 |
| 14P | 30.0 | 26.0 | 28.9 |
| 13P | 28.0 | 24.0 | 26.9 |
| 12P | 26.0 | 22.0 | 24.9 |
| 11P | 24.0 | 20.0 | 22.9 |
| 10P | 22.0 | 18.0 | 20.9 |
| 9P | 20.0 | 16.0 | 18.9 |
| 8P | 18.0 | 14.0 | 16.9 |
| 7P | 16.0 | 12.0 | 14.9 |
| 6P | 14.0 | 10.0 | 12.9 |
| 5P | 12.0 | 8.0 | 10.9 |
| 4P | 10.0 | 6.0 | 8.9 |
| 3P | 8.0 | 4.0 | 6.9 |
| 2P | 6.0 | 2.0 | 4.9 |

技术要求:

- 1) 材质:见附表;
- 2) 电镀:见附表;
- 3) 塑件表面平整、光洁、无毛刺、气泡、烧焦、变形、浇口无拉伤、多料或缺料等不良现象;
- 4) 端子表面无氧化、电镀不良等现象。

适应基板厚度: 1.2mm~1.6mm

温度范围: -25℃~85℃

额定电压: 250V AC/DC

额定电流: 2A

绝缘电阻: ≥100MΩ

耐压: 800V AC/minute

| 2 | PIN | n PCS | 材质:黄铜,电镀:镀亮锡60u*MIN |
|-----|---------|-------|-------------------------|
| 1 | Housing | 1 PCS | 材质:PA66 (UL94V-0),颜色:本色 |
| NO. | NAME | Q' TY | DESCRIPTION |

 深圳市韩下电子有限公司

| | | | | | | | |
|----------|-----|-----------|------------------|-------------|------------|-----------------|--------|
| DRAW : | 黄彬 | 2020-8-28 | TITLE: | 针座 | DRAW NAME: | HX-HY2.0-5PWZ-M | |
| DESIGN: | | | SERIES: | 1501 SERIES | DRAW NO. | | |
| CHECK: | 张伟 | 2020-8-28 | P/N: | | UNIT: | SHEET: | |
| APPROVED | 罗小春 | 2020-8-28 | CUSTOMER DRAWING | REV. 1.00 | SCALE | N/A | mm 1/1 |